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## Designing multiple charge carrier separation pathways in core-type near infrared colloidal nanocrystal for broadband photodetector†

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Near-infrared colloidal nanocrystals (NIR-CNCs) have been widely utilized in optoelectronic applications due to their exceptional optical properties and suitability for mass production. However, their practical application is often hindered by poor chemical stability and suboptimal electronic properties. In this work, four different surface ligand systems—insulating ligands, organic molecular linkers, inorganic molecular linkers, and matrix-type ligands—were systematically investigated to evaluate their effects on the transport and recombination behavior of NIR-CNCs *via* photoinduced carriers. While molecular linkers enhance transport behavior by improving electronic coupling, they tend to induce photoinduced charge carrier accumulation under AM1.5 illumination due to a high degree of Fermi-level pinning caused by unfavorable electronic structures. In contrast, the matrix-type band-like transport ligand significantly reduced dark current and hysteresis characteristics in CNCs, demonstrating superior performance. Impedance and capacitance analyses revealed that the matrix-type ligand, with its multiple carrier separation pathways, enhanced carrier transport through sub-states facilitated by amorphous MoS<sub>x</sub> and effectively passivated CNC trap states, thereby reducing the Fermi-level pinning effect. This approach dramatically suppressed hot carrier-induced trap state generation, minimized photoinduced recombination, and improved operational stability. Overall, this study presents a significant advancement in developing cost-efficient, chemically stable NIR optoelectronic devices with outstanding electronic properties.

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### Introduction

Near-infrared colloidal nanocrystals (NIR-CNCs) have attracted considerable attention due to their flexibility in device applications, cost-effectiveness, scalability for mass production, ease of control over electrical and optical properties, and

adaptability for integration into various matrices.<sup>1,2</sup> These characteristics make NIR-CNCs suitable for a wide range of applications, including thermal imaging for medical diagnostics,<sup>3</sup> forward-facing sensors in autonomous vehicles, night vision in military contexts, motion detection sensors, and solar cells.<sup>4</sup> Lead chalcogenides (PbX, where X = S, Se, or Te) and cadmium chalcogenides (CdX, where X = S, Se, or Te) are commonly employed as NIR-CNCs due to their narrow bulk band gaps, large excitonic Bohr radii, and capability for multiple exciton generation.<sup>5–8</sup> However, their practical use is restricted by environmental compatibility concerns (e.g., toxicity and safety) and stability, particularly in core-type CNCs.

Recently, copper indium chalcogenides (CuInX<sub>2</sub>, X = S, Se, or Te) have emerged as promising candidates for NIR-CNCs, offering high absorption coefficients ( $\sim 10^5$  cm<sup>-1</sup>), enhanced environmental compatibility, a direct band gap extending from the visible to the near-infrared range, and excellent tunability.<sup>9</sup> Additionally, CuInSe<sub>2</sub> (CISE<sub>2</sub>) CNCs exhibit remarkable structural tolerance, which confers improved sustainability even when stoichiometric mismatches or trap state formation occur, setting them apart from other core-type CNCs.<sup>10</sup> As all NIR-CNCs require a ligand exchange process due to the insulating

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nature of long aliphatic ligands used during synthesis, the structural robustness of  $\text{CISe}_2$  broadens the range of feasible ligand exchange methods, including those applicable under harsh conditions. This robustness also enhances the controllability of surface carrier separation pathway of  $\text{CISe}_2$  CNCs through post-treatment.

On the other hand, the low defect formation energy of  $\text{CISe}_2$  leads to the generation of a significant number of surface defects. Both shallow and deep trap states can easily form, depending on the surface state of  $\text{CISe}_2$  CNCs.<sup>11</sup> This feature hinders the performance of  $\text{CISe}_2$  in NIR applications, resulting in high dark leakage current and severe carrier recombination, which negatively impact the detectivity of photodetectors. Previous studies have demonstrated that a core-shell structure (e.g.,  $\text{CuInS}_2/\text{ZnS}$ ) can effectively reduce the number of surface defects in  $\text{CISe}_2$  CNCs, thereby improving photodetector performance. Embedding these core-shell CNCs in an organic matrix further enhances both photoresponsivity and detectivity.<sup>12</sup> However, the limited range of shell types, specifically those with type-I core-shell band structures, restricts further advancements in the light-detection capabilities of  $\text{CISe}_2$  CNCs. This limitation arises from carrier transport occurring *via* tunneling, which may hinder effective carrier separation from adjacent layers.

Other studies focus on utilizing ligand exchange with organic and inorganic ligands, both of which effectively reduce the interparticle distance of CNCs. This reduction induces efficient electronic coupling between CNCs, improving carrier transport behavior and enhancing the conductivity of the resulting films. Specifically, inorganic ligands, such as metal chalcogenide complexes, bind effectively to the CNC surface, providing electrostatic stabilization. The minimized interparticle distance facilitates strong coupling between CNCs, enabling faster carrier separation.<sup>13</sup> However, relying solely on electronic coupling between CNCs as a carrier separation pathway is insufficient to overcome performance bottlenecks in  $\text{CISe}_2$  CNC-based photodetectors, particularly due to hot carrier generation in NIR CNCs. When external bias or light intensity is increased, the concentration of photocarrier rises and becomes localized at the surface due to limited available states. This accumulation of carriers at the surface leads to recombination processes, despite the strong electronic coupling between CNCs. This phenomenon is indirectly observed as a loss of mobility in the film state. Even after annealing, the mobilities in NIR CNC films are still much lower than those of bulk materials, mainly due to hot carrier induced coulomb scattering.<sup>14</sup> Therefore, it is important not only to adjust the distance between particles but also to improve surface states to prevent carrier accumulation at the edges of  $\text{CISe}_2$  CNCs and ensure effective charge carrier transfer in these films.

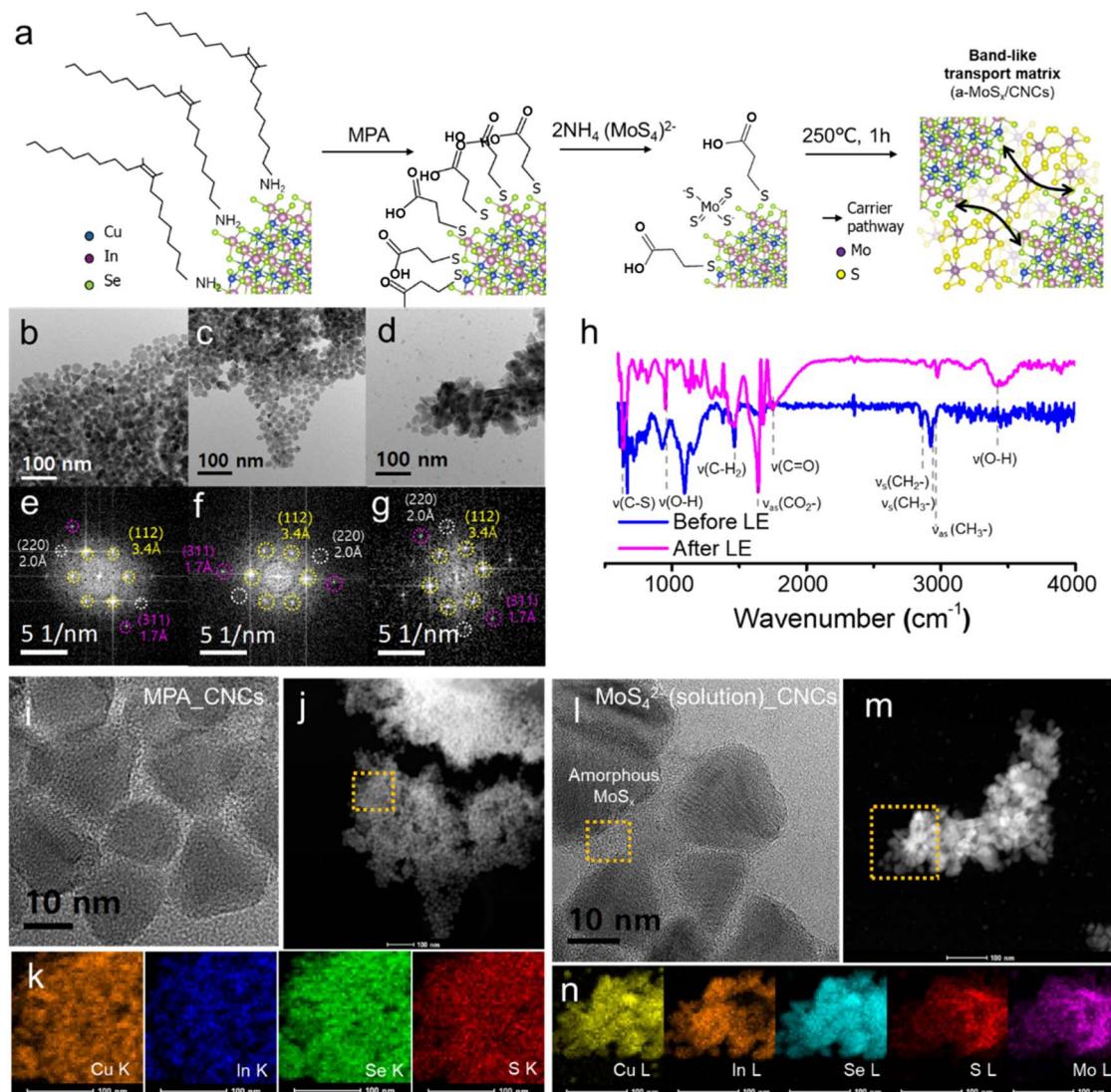
Since the optimal type of ligand for efficient charge carrier separation and reduced surface recombination remains unclear, this study applied four different types of surface ligands to  $\text{CISe}_2$  CNC-based photodetectors: oleyl amine (OL) for bare CNCs, 3-mercaptopropionic acid (MPA) as an organic molecular linker, tetrathiomolybdate ( $\text{MoS}_4^{2-}$ ) as an inorganic molecular linker, and amorphous molybdenum sulfide (a-

$\text{MoS}_x$ ) as a matrix-type linker. The photo-detectivity of the lateral-type photodetectors was demonstrated as  $1.02 \times 10^5 \text{ cm Hz}^{1/2} \text{ W}^{-1}$  for OL\_CNCs,  $7.73 \times 10^5 \text{ cm Hz}^{1/2} \text{ W}^{-1}$  for MPA\_CNCs,  $1.95 \times 10^5 \text{ cm Hz}^{1/2} \text{ W}^{-1}$  for  $\text{MoS}_4^{2-}$ \_CNCs, and  $6.28 \times 10^6 \text{ cm Hz}^{1/2} \text{ W}^{-1}$  for a-MoS<sub>x</sub>/CNCs, respectively. The devices incorporating a-MoS<sub>x</sub>/CNCs materials demonstrated the highest detectivity with  $0.146 \text{ A W}^{-1}$  responsivity, coupled with significantly enhanced response times, including accelerated rise and decay times, compared to their molecule-linked CNC counterparts. To elucidate the mechanisms responsible for the superior photodetection performance of a-MoS<sub>x</sub>/CNCs materials, the carrier separation pathways in each system were systematically investigated. Capacitance analysis under both illuminated and dark conditions revealed substantial photo-induced surface recombination in molecule-linked CNCs. In contrast, a-MoS<sub>x</sub>/CNCs film exhibited negligible increases in surface recombination, highlighting their exceptional charge carrier management under illumination, which is directly associated with enhanced photodetection performance.

## Result and discussion

Fig. 1a illustrates the schematic representation of the ligand exchange method used to produce a-MoS<sub>x</sub>/CNCs materials. OL\_CNCs, MPA\_CNCs, and  $\text{MoS}_4^{2-}$ \_CNCs were fabricated using previously reported methods,<sup>15</sup> as detailed in the experimental section. Each system was carefully selected to investigate the carrier separation and surface recombination behavior under AM1.5 illumination and their corresponding impact on photodetection performance. MPA\_CNCs was chosen as an organic molecular linker to establish moderate electronic coupling between CNCs, while  $\text{MoS}_4^{2-}$ \_CNCs was selected as an inorganic molecular linker to provide stronger electronic coupling. On the other hand, the matrix-type ligand system, a-MoS<sub>x</sub>/CNCs, was designed to study carrier separation and surface recombination behaviors, facilitated by band-like transport. As the direct counterpart to the matrix-type ligand system,  $\text{MoS}_4^{2-}$ \_CNCs enables the investigation of photoinduced charge carrier behavior and its dependence on the separation pathway. The a-MoS<sub>x</sub>/CNCs film was synthesized through a two-step ligand exchange process involving MPA and  $\text{MoS}_4^{2-}$ . This approach utilized the well-reported transformation of the  $\text{MoS}_4^{2-}$  ligand into amorphous MoS<sub>x</sub> upon annealing at temperatures exceeding  $160^\circ\text{C}$ ,<sup>16</sup> with its transformation behavior precisely controlled by adjusting the thermal annealing conditions. Initially, a solution-phase ligand exchange process with MPA was performed on the as-synthesized CNCs, followed by film fabrication *via* the spin-coating method. To create a multi-separation pathway for photocarriers, an additional solid-phase ligand exchange process was carried out using a  $\text{MoS}_4^{2-}$  solution to establish band-like transport between the CNCs and a-MoS<sub>x</sub>. The layer-by-layer deposition was repeated five times to fabricate the a-MoS<sub>x</sub>/CNCs film. Finally, the film was annealed at  $250^\circ\text{C}$  under an inert atmosphere, a condition specifically chosen to fabricate an ultrathin amorphous MoS<sub>x</sub> matrix with minimal defects. The CNCs with various ligand exchange process were examined





**Fig. 1** (a) A schematic illustration of preparation of a- $\text{MoS}_x$ /CNCs via two-step ligand exchange reaction. The TEM images of (b) OL-CNCs, (c) MPA-CNCs, and (d)  $\text{MoS}_4^{2-}(\text{solution})$ -CNCs, with FFT signals of (e) OL-CNCs, (f) MPA-CNCs and (g)  $\text{MoS}_4^{2-}(\text{solution})$ -CNCs. (h) FT-IR spectrum of OL-CNCs (before LE, pink solid line) and a- $\text{MoS}_x$ /CNCs (after LE, blue solid line). (i) HR-TEM image and (j) TEM dark-field image of MPA-CNCs with corresponding (k) EDX color mapping image. (l) HR-TEM image and (m) TEM dark-field image  $\text{MoS}_4^{2-}(\text{solution})$ -CNCs with corresponding (n) EDX color mapping image.

using high-resolution transmission electron microscopy (HRTEM) images, as shown in Fig. 1b–d, to compare the size, shape, and crystal structure of  $\text{CIS}_{\text{2}}$  CNCs after treatment. The size variation of as-synthesized CNCs ranged from 10 to 20 nm, consistent with previous reports. Fourier transform (FFT) signals, (112), (220) and (311) facets were observed with a lattice distance of 3.4 Å, 2.0 Å and 1.7 Å coinciding with the  $\text{CIS}_{\text{2}}$  chalcopyrite structure (Fig. 1e–g).<sup>17</sup> After the ligand exchange process, no significant changes were observed in the size or crystal structure of  $\text{CIS}_{\text{2}}$  for both MPA-CNCs (Fig. 1c and f) and a- $\text{MoS}_x$ /CNCs (Fig. 1d and g), suggesting that the size effect and phase-driven physical properties are negligible relative to the type of ligand exchange reaction.

The successful ligand exchange for a- $\text{MoS}_x$ /CNCs was confirmed by Fourier-transform infrared spectroscopy (FT-IR),

as shown in Fig. 1h. Prior to the ligand exchange reaction, two distinguishable peaks were observed at  $1463\text{ cm}^{-1}$  and  $2780\text{--}3000\text{ cm}^{-1}$ , respectively. The peak at  $1463\text{ cm}^{-1}$  corresponded to the  $-\text{CH}_2$  bending vibration, while the peaks in the  $2854\text{ cm}^{-1}$ ,  $2924\text{ cm}^{-1}$ , and  $2956\text{ cm}^{-1}$  were attributed to the  $-\text{CH}_2$  symmetric,  $-\text{CH}_3$  symmetric, and  $-\text{CH}_3$  asymmetric stretching vibration which are characteristic of the oleyl group in aliphatic ligands.<sup>18</sup> Following the two-step ligand exchange process, the intensities of these peaks significantly decreased, indicating a reduction in oleyl amine on the surface of  $\text{CIS}_{\text{2}}$ . Moreover, new peaks emerged at  $3400\text{ cm}^{-1}$ ,  $1753\text{ cm}^{-1}$ ,  $1641\text{ cm}^{-1}$ ,  $948\text{ cm}^{-1}$ , and a prominent peak at  $638\text{ cm}^{-1}$ , corresponding to the H-bonded OH stretch, C=O stretch, asymmetric  $\text{CO}_2^-$  stretch, out-of-plane bending mode of O–H, and C–S bonding, respectively.<sup>19</sup> Notably, no absorption was



observed in the  $2550\text{ cm}^{-1}$  region, corresponding to S-H bonding, indicating the cleavage of S-H bonds during the ligand exchange process. This suggests the predominance of metal-sulfur bonds over metal-COOH groups in the system.<sup>20</sup> These results confirm the successful replacement of oleyl amine ligands with MPA ligands, which remained intact during the secondary ligand exchange process with  $\text{MoS}_4^{2-}$ . The HRTEM (Fig. 1i and j) and associated energy-dispersive X-ray spectroscopy (EDX) mapping were further conducted to confirm the ligand exchange behavior of organic and inorganic linker. EDX elemental mapping of S from MPA demonstrated a homogeneous distribution after the MPA ligand exchange, like that of Cu, In, and Se, which are components of CNCs (Fig. 1k). On the other hand, the solution-phase  $\text{MoS}_4^{2-}$  ligand exchange process revealed the presence of amorphous  $\text{MoS}_x$ -matrix between the CNCs, unlike MPA\_CNCs, which formed from  $\text{MoS}_4^{2-}$  activated by electron beam irradiation (Fig. 11n). This observation confirms the successful amorphization of  $\text{MoS}_4^{2-}$  using our method. Interestingly, the solution-phase  $\text{MoS}_4^{2-}$  exchange exhibited higher intensities of Mo and S near the aggregated CNCs, unlike the MPA treatment, while EDX mapping of In revealed a decrease in intensity near the aggregated CNCs. This suggests that the solution-phase  $\text{MoS}_4^{2-}$  treatment is not uniformly deposited on the surface of the CNCs. Negligible peak shift and broadening in the X-ray photoelectron spectroscopy (XPS) spectrum of CNCs treated with solution-phase  $\text{MoS}_4^{2-}$  confirm the absence of a significant increase in surface defects during the ligand exchange process (Fig. S1†), consistent with the EDX observations. The solution-phase process causes excess

$\text{MoS}_4^{2-}$  to accumulate near aggregated CNCs, resulting in inhomogeneous film formation. Therefore, we optimized the two-step ligand exchange method by combining MPA treatment with a solid-state ligand exchange for  $\text{MoS}_4^{2-}$ , rather than using the solution-phase method. This approach proved more effective in fabricating homogeneous photodetectors.

XPS analysis was performed on all samples, including OL\_CNCs, MPA\_CNCs,  $\text{MoS}_4^{2-}$ \_CNCs, and a- $\text{MoS}_x$ /CNCs, after annealing at  $250\text{ }^\circ\text{C}$  to assess defect formation in each system. Since  $\text{ClSe}_2$  CNCs tend to form off-stoichiometric compositions, which are known to generate defects due to their low defect formation energy, the defect generation associated with each ligand exchange method was examined. These defects (e.g., type, concentration) are expected to significantly influence charge transport behavior, which is a key parameter for altering photodetector performance.<sup>13</sup> In the core-level spectra of Cu 2p for OL\_CNCs, MPA\_CNCs, and  $\text{MoS}_4^{2-}$ \_CNCs, two main peaks at  $951.7\text{ eV}$  and  $931.8\text{ eV}$ , corresponding to  $\text{Cu 2p}_{1/2}$  and  $\text{Cu 2p}_{3/2}$ , respectively, were observed (Fig. 2a). These three  $\text{ClSe}_2$  CNCs exhibited a slight red-shift compared to stoichiometrically accurate  $\text{ClSe}_2$  from previous studies,<sup>21</sup> indicating the Cu-deficient nature of our synthesized materials and the presence of defect pairs, ( $2\text{V}_{\text{Cu}}^{-}$  and  $\text{In}_{\text{Cu}}^{2+}$ ), which have the lowest defect formation energy.<sup>10,11</sup> Consequently, the molecular linkers (MPA and  $\text{MoS}_4^{2-}$ ) did not induce notable charge redistribution on the Cu 2p orbital, as both MPA\_CNCs and  $\text{MoS}_4^{2-}$ \_CNCs showed no significant binding energy shifts in the Cu 2p core-level spectra when compared to OL\_CNCs ( $\text{ClSe}_2$  without ligand exchange processing). After the two-step ligand exchange

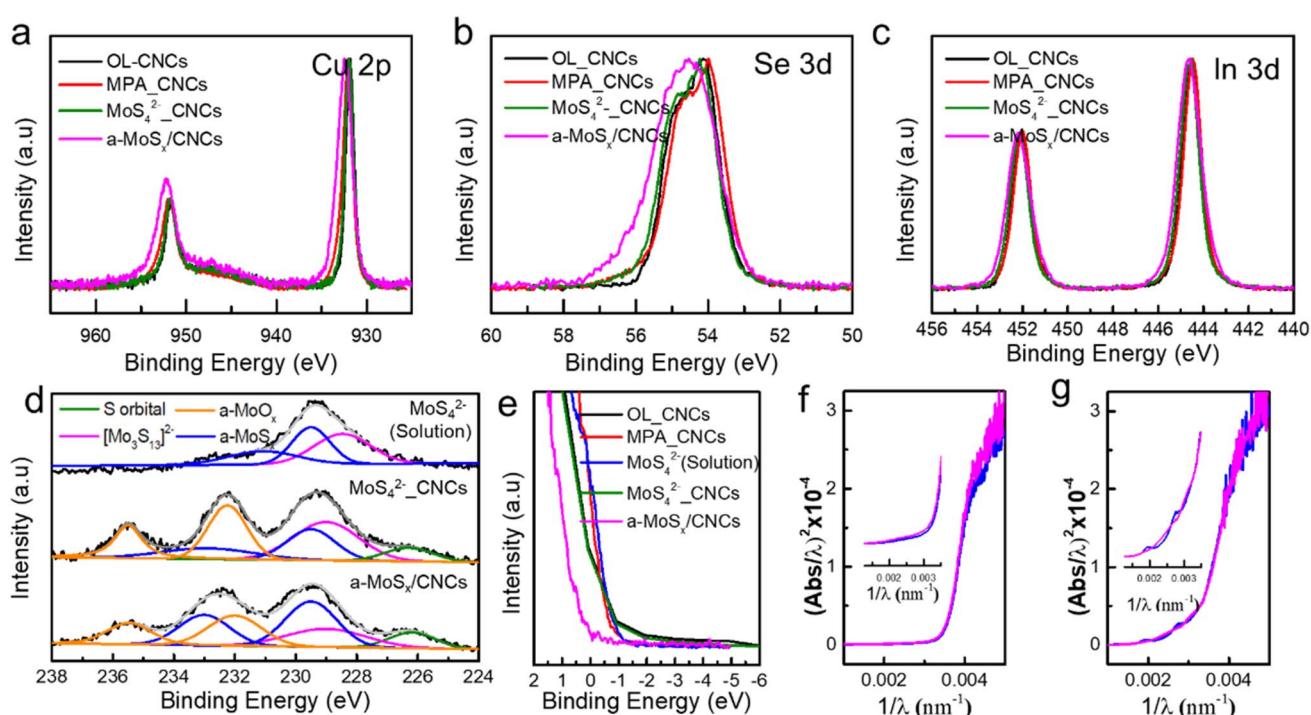


Fig. 2 XPS core-level spectrum of (a) Cu 2p, (b) Se 3d and (c) In 3d of OL\_CNCs, MPA\_CNCs,  $\text{MoS}_4^{2-}$ \_CNCs and a- $\text{MoS}_x$ /CNCs respectively. (d) Mo 3d core-level spectrum of  $\text{MoS}_4^{2-}$ (solution)\_CNCs,  $\text{MoS}_4^{2-}$ \_CNCs and a- $\text{MoS}_x$ /CNCs. (e) Valence band spectrum of OL\_CNCs, MPA\_CNCs,  $\text{MoS}_4^{2-}$ (solution)\_CNCs,  $\text{MoS}_4^{2-}$ \_CNCs and a- $\text{MoS}_x$ /CNCs. DASF spectrum of (f) MPA\_CNCs and (g) a- $\text{MoS}_x$ /CNCs.



process (*i.e.*, a-MoS<sub>x</sub>/CNCs), a blue shift in the binding energy of Cu 2p orbital was observed, along with an increase in full width half maximum (FWHM). The peak positions were similar to those of stoichiometrically accurate CISe<sub>2</sub>, but exhibited greater peak broadening compared to CISe<sub>2</sub>. The peak broadening in a-MoS<sub>x</sub>/CNCs is attributed to band bending, which results from the band-like transport characteristics of the matrix-type a-MoS<sub>x</sub>. Thus, the matrix-type ligand is expected to reduce surface defects and promote charge redistribution of Cu–Se, influenced by the adjacent S-enriched environment, thereby improving the electronic properties of the material. A similar trend was observed in the Se 3d (Fig. 2b) and In 3d (Fig. 2c) orbitals. The core-level spectra of Se 3d and In 3d exhibited shifts to higher binding energies and increased FWHM in a-MoS<sub>x</sub>/CNCs compared to the other samples.<sup>22</sup> It is noteworthy that the shift in binding energy for In 3d appeared smaller compared to Cu 2p and Se 3d, as the In–Se bond exhibits weaker covalency than the Cu–Se bond.<sup>21</sup>

To elucidate the role of the a-MoS<sub>x</sub> matrix within CNC thin films, the Mo 3d core-level spectra of all MoS<sub>4</sub><sup>2-</sup>-treated CNCs were investigated after annealed at 250 °C under inert conditions. This included MoS<sub>4</sub><sup>2-</sup> treated in solution phase (MoS<sub>4</sub><sup>2-</sup>(solution)\_CNCs), MoS<sub>4</sub><sup>2-</sup> treated in solid phase (MoS<sub>4</sub><sup>2-</sup>\_CNCs), and MPA-MoS<sub>4</sub><sup>2-</sup> two-step ligand treated CNCs (a-MoS<sub>x</sub>/CNCs). Ammonium tetrathiomolybdate transforms into various compositions, including crystalline MoS<sub>2</sub> (trigonal or hexagonal), crystalline S-deficient MoS<sub>x</sub> ( $x < 2$ ), and S-rich MoS<sub>x</sub> amorphous phases, depending on the thermal annealing conditions.<sup>22,23</sup> Investigating the chemical bonding and oxidation states of molybdenum is crucial, as the electronic properties of these Mo–S derivatives depend heavily on their compositions.<sup>25</sup> MoS<sub>4</sub><sup>2-</sup>(solution)\_CNCs, which was treated with solution phase MoS<sub>4</sub><sup>2-</sup>, exhibited dominant peaks at 229.4 eV and 232.4 eV, confirming the formation of the [Mo<sub>3</sub>S<sub>13</sub>]<sup>2-</sup> cluster with a minor amount of amorphous a-MoS<sub>x</sub> rather than the 2H-MoS<sub>2</sub> phase (Fig. 2d).<sup>24,25</sup> This is consistent with previous studies, which indicate that MoS<sub>4</sub><sup>2-</sup> initially forms MoS<sub>3</sub> and transitions to the 2H-MoS<sub>2</sub> phase only at temperatures exceeding 500 °C. The significant intensity difference between the Mo 3d<sub>5/2</sub> and Mo 3d<sub>3/2</sub> peaks further confirms the molecular nature of MoS<sub>x</sub> in MoS<sub>4</sub><sup>2-</sup>(solution)\_CNCs, as opposed to a crystalline structure. For MoS<sub>4</sub><sup>2-</sup>\_CNCs, which was treated with MoS<sub>4</sub><sup>2-</sup> in solid phase, dominant peaks at 229.4 eV and 232.4 eV were observed, indicating a high concentration of [Mo<sub>3</sub>S<sub>13</sub>]<sup>2-</sup> clusters, along with a slightly increased proportion of a-MoS<sub>x</sub>. Additionally, partial amorphous oxide peaks at 232.4 eV and 235.4 eV were also detected, resulting from oxygen trapped during the spin-coating process that oxidized molybdenum during annealing. Notably, the Mo 3d spectra of a-MoS<sub>x</sub>/CNCs exhibited blue-shifted peaks at 229.6 eV and 232.7 eV, characteristic of an amorphous, sulfur rich MoS<sub>x</sub> phase.<sup>26</sup> This increased portion of a-MoS<sub>x</sub> is attributed to the homogeneous deposition of MoS<sub>4</sub><sup>2-</sup>, which promotes the formation of matrix-type a-MoS<sub>x</sub>. Similarly, the S 2p orbital displayed a blue-shifted peak in a-MoS<sub>x</sub>/CNCs, which is attributed to an increased fraction of S–S bridges compared to S–S terminals (Fig. S2†).<sup>24</sup> This shift provides

evidence for the predominance of an amorphous phase in a-MoS<sub>x</sub>/CNCs. Furthermore, the reduced intensity of the amorphous oxide peaks at 232.4 eV and 235.4 eV indicates enhanced material stability.

This improved stability suggests that the MPA ligands on CNCs facilitate the uniform anchoring of MoS<sub>4</sub><sup>2-</sup> on their surfaces, resulting in an enriched MoS<sub>4</sub><sup>2-</sup> environment. The hydrogen bonding provided by the COOH groups, combined with the increased London dispersion forces from the benzene rings of MPA, prevents CNC aggregation while providing sufficient space for the formation of Mo–S derivative networks.<sup>27</sup> Consequently, the enriched MoS<sub>4</sub><sup>2-</sup> environment effectively occupies Se vacancies or incorporates into voids and grain boundaries. Upon annealing, this enriched MoS<sub>4</sub><sup>2-</sup> undergoes a successful transformation into an amorphous MoS<sub>x</sub> matrix, which can facilitate band-like transport. This observation was further supported by the valence band spectra shown in Fig. 2e. The Fermi level of a-MoS<sub>x</sub>/CNCs shifted by approximately 0.8 eV compared to that of other samples, which is attributed to the reduction of defect states induced by a-MoS<sub>x</sub> matrix. In contrast, MPA\_CNCs and MoS<sub>4</sub><sup>2-</sup>\_CNCs exhibited no significant change near the Fermi level relative to OL\_CNCs. The defect states in CISe<sub>2</sub>, which exist within the NIR band gap, are located above the valence band and beneath the conduction band. These defect states tend to neutralize the charge and compensate each other, leading to Fermi level pinning, which significantly affects photocarrier transport behavior.<sup>28</sup> Due to strong Fermi level pinning, the band edge state and band tail remained unchanged for MPA\_CNCs or MoS<sub>4</sub><sup>2-</sup>\_CNCs (Fig. 2f). However, a-MoS<sub>x</sub>/CNCs exhibited blue shift (Fig. 2g), indicating the removal of existing vacancies and strong coupling between the Se core and MoS<sub>x</sub>, attributed to a decrease in the electron cloud density of Se.<sup>29</sup> These findings indicate that the two-step ligand exchange method is highly effective in fabricating a matrix-type band-like ligand system. This system enhances charge carrier transport efficiency by physically and electronically passivating defects, thereby significantly improving photodetection performance.

Finally, photoconductors based on four different types of CNC networks were fabricated to evaluate their photo-induced current. Scanning electron microscope (SEM) images were obtained to examine the uniformity of the surface morphology of the photodetector (Fig. S3†). As no significant differences were observed in factors that could influence device characteristics, such as grain boundaries or surface roughness, the measured photodetector performance can be primarily attributed to the ligand systems within the active layer. A lateral-type channel was employed as shown in Fig. S4† for this study, as opposed to layered-structured devices, to analyze charge separation and photoinduced surface recombination behavior within the CNC networks, depending on the surface ligand system. Photocurrent measurements were conducted under light irradiation using a Xenon lamp at 100 mW cm<sup>-2</sup> intensity (AM1.5), as shown in Fig. 3a-d. To prevent the overestimation of photocurrent in the photodetector, the device was exposed to light over an area larger than its active area.<sup>30,31</sup> For OL\_CNCs, MPA\_CNCs, MoS<sub>4</sub><sup>2-</sup>(solution), and a-MoS<sub>x</sub>/CNCs-based



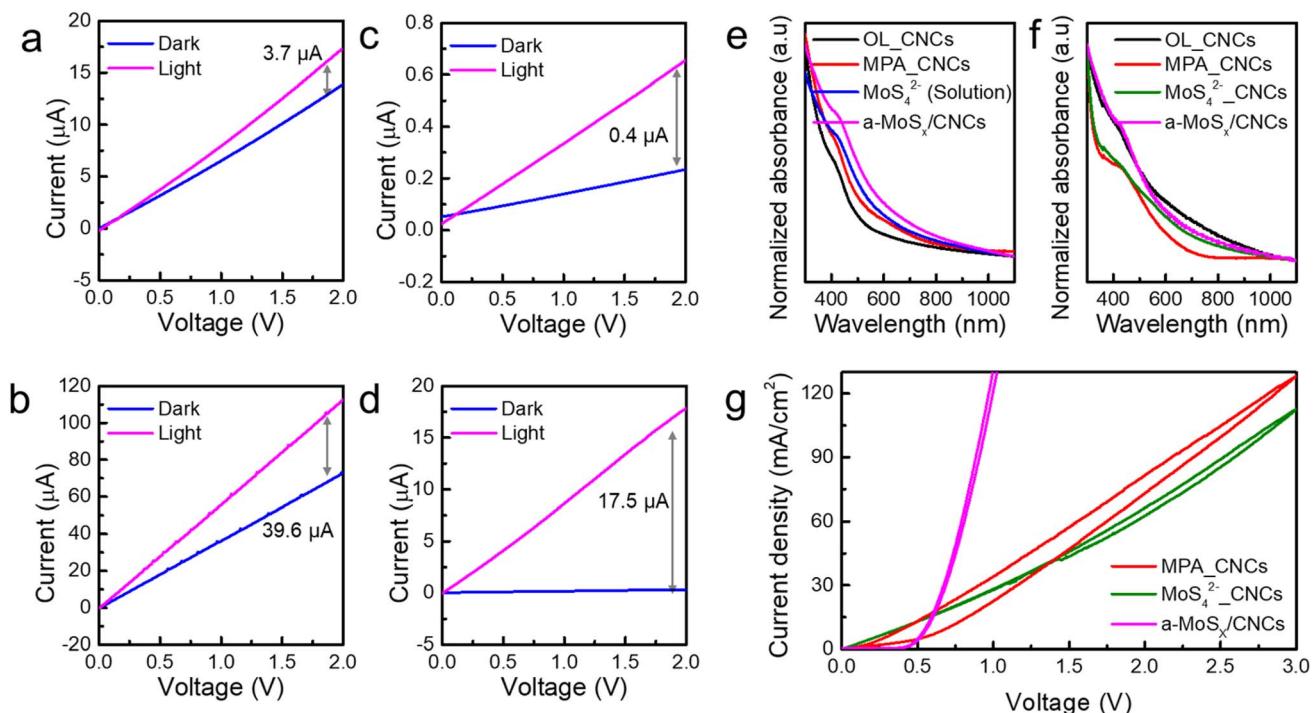


Fig. 3 Static-state responsivity for (a) OL\_CNCs, (b) MPA\_CNCs, (c) MoS<sub>4</sub><sup>2-</sup>(solution)\_CNCs and (d) a-MoS<sub>x</sub>/CNCs using a Xenon lamp at 100 mW cm<sup>-2</sup> intensity. (e) The normalized absorption spectrum measured in solution phase OL\_CNCs (black), MPA\_CNCs (red), MoS<sub>4</sub><sup>2-</sup>(solution)\_CNCs (blue) and a-MoS<sub>x</sub>/CNCs (pink). (f) The normalized absorption spectrum measured in thin-film phase OL\_CNCs (black), MPA\_CNCs (red), MoS<sub>4</sub><sup>2-</sup>\_CNCs (green), and a-MoS<sub>x</sub>/CNCs (pink). (g) The hysteresis curve of MPA\_CNCs (red), MoS<sub>4</sub><sup>2-</sup>\_CNCs (green) and a-MoS<sub>x</sub>/CNCs (pink).

photodetectors, measured at a 2V bias and obtained by subtracting the dark current, exhibited the following trend: MPA\_CNCs (39.6  $\mu$ A) > a-MoS<sub>x</sub>/CNCs (17.5  $\mu$ A) > OL\_CNCs (3.7  $\mu$ A) > MoS<sub>4</sub><sup>2-</sup>(solution) (0.4  $\mu$ A). In contrast, the dark current followed a different trend: MPA\_CNCs (73.0  $\mu$ A) > OL\_CNCs (13.5  $\mu$ A) > a-MoS<sub>x</sub>/CNCs (0.33  $\mu$ A) > MoS<sub>4</sub><sup>2-</sup>(solution) (0.23  $\mu$ A). Notably, MPA\_CNCs demonstrated the highest photocurrent and dark current due to the increment of acceptor states, therefore both photo-generated and majority charge carrier increased. The dark current in NIR materials is closely related to the number of majority charge carriers. As the trap density increases in NIR-CNCs, these trap states behave as dopants, contributing to a higher concentration of majority charge carriers. The presence of these trap states facilitates the generation of thermally excited carriers and promotes inter-particle band to band transition between neighboring CNCs, ultimately leading to an increase in the dark current.<sup>32</sup> Consequently, a 10-order magnitude increase in both photo and dark currents was observed in MPA\_CNCs compared to OL\_CNCs, which can be attributed to the synergistic effect between MPA doping and intrinsic p-type defects. On the other hand, MoS<sub>4</sub><sup>2-</sup>(solution) (Fig. 3c) and MoS<sub>4</sub><sup>2-</sup>\_CNCs (Fig. S5†) demonstrated decreases in both photo (0.92  $\mu$ A) and dark currents (1.64  $\mu$ A). The morphological inhomogeneity observed in the TEM images negatively impacted the photodetection behavior of the MoS<sub>4</sub><sup>2-</sup>(solution) film, and MoS<sub>4</sub><sup>2-</sup>\_CNCs (solid state exchange) exhibited reduced electronic coupling between CNCs, attributed to the presence of a large amount of residual

OL. Interestingly, a-MoS<sub>x</sub>/CNCs demonstrated significantly suppressed dark current due to effective defect passivation, ensuring stability throughout operation (Fig. S6a†). Although MPA\_CNCs exhibited the highest photoresponsivity, their dark current gradually increased during operation (Fig. S6b†). This increase was attributed to hot carriers further enhancing trap states, leading to universal mobility degradation.<sup>33</sup> Once the dark current of MPA\_CNCs photodetector reached approximately the ~1 mA scale, the device ceased to exhibit any photoresponsivity. The robustness of a-MoS<sub>x</sub>/CNCs allowed its photodetector to maintain consistent operation even after one month of storage (Fig. S7a†) and 100 operational cycles (Fig. S7b†).

To clarify the reasons behind the enhanced photodetection behavior and robustness of a-MoS<sub>x</sub>/CNCs, the optical band gap of each system was measured and analyzed. The normalized absorption spectrum of CIS<sub>2</sub> with various ligands is depicted in Fig. 3e. The absorption shoulder peak at 460 nm corresponding to the excitation peak of CIS<sub>2</sub>, was preserved across all samples.<sup>21</sup> This suggests that the long-range electronic structure and structural properties of CNCs were maintained during the three different ligand exchange treatments, consistent with the results observed in TEM investigations. The absorption spectra of all samples showed that absorption near the 460 nm was still preserved even after annealing, which is distinguishable features of CIS<sub>2</sub> (Fig. 3f). Therefore, the enhanced photo-detection properties of a-MoS<sub>x</sub>/CNCs were not attributed to the change of intrinsic band structure which is well coincident with



ligand chemistry study. To investigate the effect of defect presence, hysteresis curve of each sample was obtained as shown in Fig. 3g. MPA\_CNCs exhibited the largest hysteresis, suggesting that severe number of trap states, which influences the material's charge transport properties.<sup>34</sup> Low conductivity with low degree of hysteresis of  $\text{MoS}_4^{2-}$ \_CNCs can be attributed to the synergistic effect of interparticle distance modulation and the additional donor states introduced by  $\text{MoS}_4^{2-}$  derivative (*i.e.*,  $[\text{Mo}_3\text{S}_{13}]^{2-}$  and a small portion of  $\text{MoS}_x$ ). This combination enhances charge separation, which explains the smaller hysteresis observed in  $\text{MoS}_4^{2-}$ \_CNCs compared to MPA\_CNCs. On the other hand, a-MoS<sub>x</sub>/CNCs exhibiting the smallest hysteresis which indicates the presence of fewer trap states, suggesting that the a-MoS<sub>x</sub> matrix maintains relatively stable electronic properties. With lower defect density and optimized electronic structure, the a-MoS<sub>x</sub>/CNCs demonstrate improved charge transport and material stability, making them a promising candidate for enhanced performance in photodetector applications.

Since amount of a-MoO<sub>x</sub> slightly different between  $\text{MoS}_4^{2-}$ \_CNCs and a-MoS<sub>x</sub>/CNCs, we further investigated photodetection behavior of a-MoS<sub>x</sub>/CNCs samples under two different annealing environments: a-MoO<sub>x</sub> fabricated under air condition (a-MoS<sub>x</sub>/CNCs\_Air), and a-MoO<sub>x</sub> fabricated with MeOH rich film under Ar condition (a-MoS<sub>x</sub>/CNCs\_MeOH\_Ar). As shown in Fig. S8a,<sup>†</sup> the sample annealed in air exhibited a significantly stronger a-MoO<sub>x</sub> peak compared to a-MoS<sub>x</sub>/CNCs annealed under Ar, both with and without residual MeOH. The a-MoS<sub>x</sub>/CNCs\_Air exhibited the highest MoO<sub>x</sub> intensity and the lowest S orbital intensity. Since the oxygen source originated externally, a-MoS<sub>x</sub>/CNCs\_Air primarily formed surface a-MoO<sub>x</sub> during the annealing process. In contrast, a-MoS<sub>x</sub>/CNCs\_MeOH\_Ar displayed lower a-MoO<sub>x</sub> intensity and higher S orbital intensity compared to a-MoS<sub>x</sub>/CNCs\_Air. However, when compared to a-MoS<sub>x</sub>/CNCs\_Ar, a-MoS<sub>x</sub>/CNCs\_MeOH\_Ar showed increased a-MoO<sub>x</sub> intensity and decreased S orbital intensity, indicating reduced S-S bonding. This suggests that most of the oxidation in a-MoS<sub>x</sub>/CNCs\_MeOH\_Ar originated from residual MeOH trapped within the film, leading to the formation of a-MoO<sub>x</sub> within the CNCs network and disrupting the continuity of the MoS<sub>x</sub> matrix. The photodetection performance of a-MoS<sub>x</sub>/CNCs\_Air and a-MoS<sub>x</sub>/CNCs\_MeOH\_Ar samples clearly demonstrated the distinct effects of surface a-MoO<sub>x</sub> and network-embedded a-MoO<sub>x</sub> within the CNCs network (Fig. S8b and c<sup>†</sup>). The a-MoS<sub>x</sub>/CNCs\_Air sample exhibited a slight reduction in photocurrent and an increase in dark current, whereas a-MoS<sub>x</sub>/CNCs\_MeOH\_Ar showed a significantly reduced photocurrent with negligible changes in dark current compared to a-MoS<sub>x</sub>/CNCs\_Ar. These results suggest that surface a-MoO<sub>x</sub> has minimal impact on the carrier transport behavior of CISe<sub>2</sub> CNCs, while a-MoO<sub>x</sub> embedded within the network severely disrupts charge transport. Based on these findings, the differences in photodetection behavior between  $\text{MoS}_4^{2-}$ \_CNCs and a-MoS<sub>x</sub>/CNCs are primarily attributed to the disruption of the a-MoS<sub>x</sub> matrix caused by embedded a-MoO<sub>x</sub>.

Interestingly, the increased trap states lead to surface recombination loss under dark conditions, while enhanced

recombination for photoinduced carriers under AM1.5 illumination. The on-off behavior of each sample clearly demonstrated distinct charge transport dynamics. The static-state responsivity for each sample was determined as follows (Fig. 3a-d): 1.8  $\mu\text{A}$  (OL\_CNCs), 13.5  $\mu\text{A}$  (MPA\_CNCs), 0.2  $\mu\text{A}$  ( $\text{MoS}_4^{2-}$ \_CNCs), and 8.8  $\mu\text{A}$  (a-MoS<sub>x</sub>/CNCs). Under dynamic-state conditions, the responsivity followed a trend of 0.03  $\mu\text{A}$  for OL\_CNCs, 0.33  $\mu\text{A}$  for MPA\_CNCs, 0.05  $\mu\text{A}$  for  $\text{MoS}_4^{2-}$ \_CNCs, and 1.34  $\mu\text{A}$  for a-MoS<sub>x</sub>/CNCs (Fig. 4a-d). Remarkably, the responsivity of the a-MoS<sub>x</sub>/CNCs-based photodetector was quite similar with that of MPA\_CNCs during dynamic-state measurements. In addition, OL\_CNCs and MPA\_CNCs exhibited dramatically elevated off-current, while  $\text{MoS}_4^{2-}$ \_CNCs and a-MoS<sub>x</sub>/CNCs showed stable on-to-off behavior during four cycles, indicating more efficient charge separation and retention (Fig. S9<sup>†</sup>). The rise and decay times were significantly longer for OL\_CNCs and MPA\_CNCs compared to  $\text{MoS}_4^{2-}$ \_CNCs (which showed an 86% recovery at 10 s but did not fully decay) and a-MoS<sub>x</sub>/CNCs (with a decay time of approximately 1 second). These results suggest that the  $\text{MoS}_4^{2-}$ -derived surface modification influences the reduced photoinduced carrier recombination, potentially improving the stability of CNCs and photoinduced charge separation of  $\text{MoS}_4^{2-}$ \_CNCs and a-MoS<sub>x</sub>/CNCs compared to OL\_CNCs and MPA\_CNCs. Additionally, impedance analysis was conducted using an FTO/NiO<sub>x</sub>/active materials/GaIn device structure to investigate the photoinduced carrier recombination behavior across different ligand systems. Capacitance changes with frequency were measured under both light and dark conditions (Fig. 4e and f). For MPA\_CNCs, a significant capacitance loss was observed primarily in the low-frequency region, suggesting that photoinduced carriers tend to accumulate due to surface recombination processes.<sup>35</sup> This behavior indicates that acceptor states play a significant role in hindering efficient charge transport in MPA\_CNCs by promoting carrier recombination at the surface, which was reported in CISe<sub>2</sub> passivated with excess sulfur.<sup>36</sup> In the case of OL\_CNCs, a larger capacitance loss was also observed in the low-frequency region. However, the frequency dependence was drastically reduced compared to MPA\_CNCs. This behavior suggests that the photoinduced carrier accumulation in OL\_CNCs primarily stems from the insulating nature of the oleyl amine ligands. These ligands contribute to surface recombination and influence the morphology-dependent resistance rather than being directly related to trap states (*i.e.*, vacancy and dopant state). On the other hand, for  $\text{MoS}_4^{2-}$ \_CNCs and a-MoS<sub>x</sub>/CNCs, the capacitance changes were more evenly distributed across both low and high-frequency regions. Although the capacitance changes were still more pronounced in the low-frequency region, the extent of the changes was significantly smaller than those observed for MPA\_CNCs. Additionally, the capacitance differences with and without light for  $\text{MoS}_4^{2-}$ \_CNCs and a-MoS<sub>x</sub>/CNCs remained below several nF at frequencies above 1 kHz. This behavior indicates that  $\text{MoS}_4^{2-}$ \_CNCs and a-MoS<sub>x</sub>/CNCs exhibit reduced hot carrier generation.<sup>37</sup> The strong electronic coupling facilitated by  $\text{MoS}_4^{2-}$  ligands and the stable electronic properties of the a-MoS<sub>x</sub> matrix effectively minimize the influence of trap states as



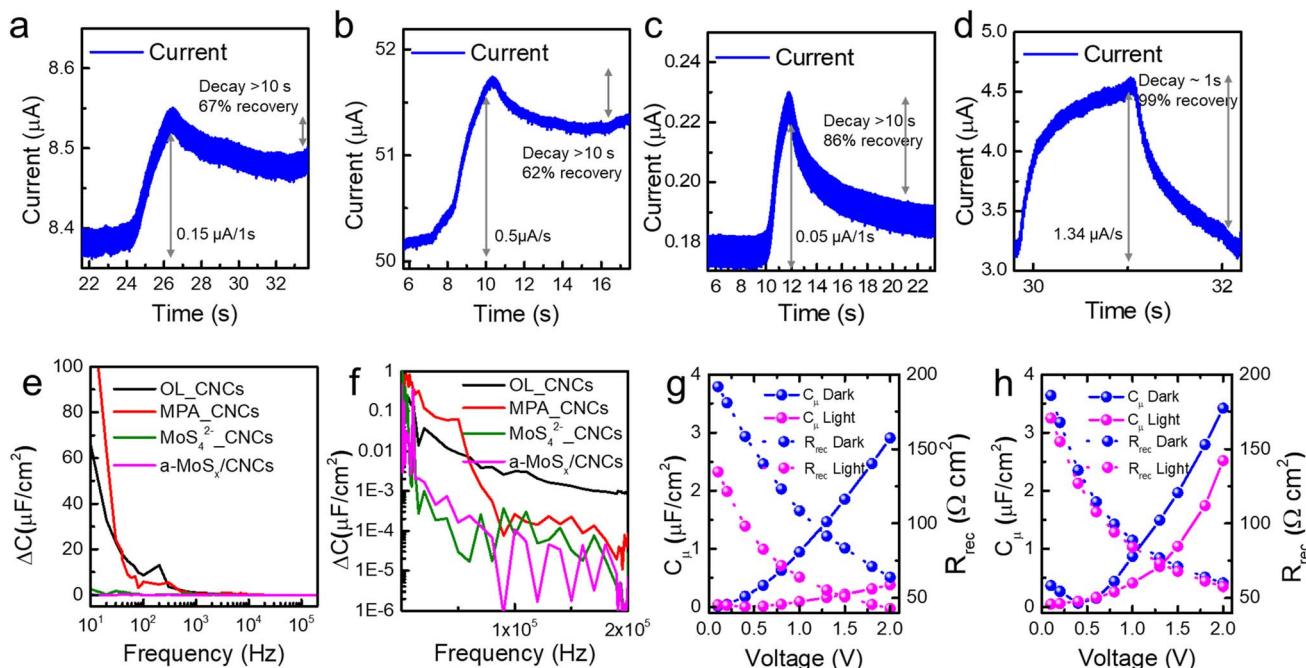


Fig. 4 On-off response of photodetectors with (a) OL\_CNCs, (b) MPA\_CNCs, (c) MoS<sub>4</sub><sup>2-</sup>\_CNCs (solution), and (d) a-MoS<sub>x</sub>/CNCs. Photoinduced capacitance as a function of frequency for CNCs with four different ligand systems presented on (e) a linear scale and (f) a logarithmic scale: OL\_CNCs, MPA\_CNCs, MoS<sub>4</sub><sup>2-</sup>\_CNCs, and a-MoS<sub>x</sub>/CNCs. Voltage versus chemical capacitance and recombination resistance plots under light and dark conditions for (g) MPA\_CNCs and (h) a-MoS<sub>x</sub>/CNCs.

well as diversifying charge carrier separation pathways. This charge separation can be explained by the rapid drift of charge carriers in the depletion region. By forming a continuous matrix outside the CNCs, it behaves like a bulk material rather than individual molecules, creating a band-like density of states. This feature, combined with the electron-rich characteristics of a-MoS<sub>x</sub>, forms a homogeneous junction with the p-type CNCs. Consequently, a depletion region is established at the interface between the a-MoS<sub>x</sub> matrix and CNCs, contributing to the enhanced performance of the photodetector.<sup>38,39</sup> Interestingly, a slight increase in photoinduced capacitance at high-frequency regions suggests morphological inhomogeneity in MoS<sub>4</sub><sup>2-</sup>\_CNCs, aligning with prior observations. As a result, a-MoS<sub>x</sub>/CNCs demonstrates superior efficiency in charge separation and transport compared to MPA\_CNCs and MoS<sub>4</sub><sup>2-</sup>\_CNCs.

Moreover, the capacitance and resistance were examined under varying voltage conditions, both with and without light exposure, in the low-frequency range (around 1 kHz). This frequency range was selected because it is particularly sensitive to the effects of surface recombination and charge transport dynamics. Under illumination, MPA\_CNCs displayed significant changes in both chemical capacitance and recombination resistance (Fig. 4f).<sup>40</sup> The resistance decreased notably in the presence of light, indicating enhanced recombination of mobile charge carriers. This reduction in resistance correlates with decreased charge separation efficiency, emphasizing the detrimental role of surface recombination.<sup>41</sup> Simultaneously, the capacitance dropped, reflecting a reduction in induced polarization likely caused by diminished separation of photoinduced

carriers. These findings demonstrate that the high density of acceptor states in MPA\_CNCs results in imbalance of majority and minor carrier, thereby hindering efficient carrier transport under AM1.5 illumination. In contrast, a-MoS<sub>x</sub>/CNCs exhibited minimal changes in capacitance and resistance under similar conditions (Fig. 4g). This suggests that photoinduced recombination is effectively suppressed in a-MoS<sub>x</sub>/CNCs, leading to more stable charge transport through multiple pathways. The minimal variations in capacitance and resistance highlight the ability of the a-MoS<sub>x</sub> matrix to mitigate trap-state-induced recombination. This improvement can be attributed to strong electronic coupling facilitated by the molecular linker and the band-like transition between CNCs and the amorphous MoS<sub>x</sub> phase, as observed in the XPS analysis. These synergistic effects enhance charge separation and promote efficient photocarrier transport in a-MoS<sub>x</sub>/CNCs, making them a robust material for optoelectronic applications. To further evaluate the applicability of this system, additional photodetection performance were conducted under low-energy light exposure. Photodetection and impedance studies across four different ligand systems confirmed that the a-MoS<sub>x</sub> matrix ligand system effectively passivates defects both physically and electronically. This suggests its potential to overcome the performance limitations of NIR photodetectors caused by unintended hot carrier generation from narrow bandgap materials. As shown in Fig. S10,† a-MoS<sub>x</sub>/CNCs based photodetector demonstrated a responsivity of 0.150 A W<sup>-1</sup> and a specific detectivity of 6.63 × 10<sup>6</sup> cm·Hz<sup>1/2</sup>·W<sup>-1</sup> under low-energy light illumination (660 nm laser with 200 mW cm<sup>-2</sup> light intensity). These findings indicate



that the matrix-type ligand system are able to enhance NIR photodetector performance by providing a continuous a-MoS<sub>x</sub> matrix that minimizes charge carrier trapping and hot carrier generation under AM1.5 illumination.

In conclusion, this study intensively investigated the distinct electronic coupling behavior and resulting photodetection performance associated with different ligand systems: (1) the original long-chain insulating ligand, OL; (2) a short-chain organic ligand, MPA; (3) a short inorganic molecule with a distinct energy state, the MoS<sub>4</sub><sup>2-</sup> ligand; and (4) a combination of short-distance ligands with distinct electronic structures, a-MoS<sub>x</sub>/CNCs (MPA + MoS<sub>4</sub><sup>2-</sup>). OL\_CNCs exhibited detrimental effects when applied directly to devices, underscoring a common limitation of traditional colloidal nanomaterial synthesis. To address these shortcomings, short-length ligands, MPA and MoS<sub>4</sub><sup>2-</sup>, were employed. Although the MPA ligand reduced interparticle distance, it resulted in increased dark current and photoinduced charge accumulation due to carrier imbalance arising from an unfavorable energy level, ultimately degrading photodetection performance. In contrast, MoS<sub>4</sub><sup>2-</sup> ligand offered a favorable energy level structure but resulted in severe film non-uniformity due to low colloidal solution stability, leading to an increased interparticle distance and hindered electronic coupling. Consequently, while photoinduced charge accumulation decreased significantly, the responsivity of photodetection also diminished. A solid-state ligand exchange method for the MoS<sub>4</sub><sup>2-</sup> ligand was introduced to improve uniformity, but it failed to overcome the limitations imposed by the long chain length of the OL ligand. This suggested that both interparticle distance and appropriate electronic structure should be considered in the selection of ligands. Based on the results, a novel ligand system using a-MoS<sub>x</sub> as a matrix-type linker was developed for CISe<sub>2</sub> CNC-based photodetectors. This integration achieved the highest detectivity ( $6.28 \times 10^6 \text{ cm} \cdot \text{Hz}^{1/2} \cdot \text{W}^{-1}$ ) and exhibited stable operation compared to the other systems investigated. The enhanced performance is attributed to the a-MoS<sub>x</sub> matrix's ability to suppress defect-induced hot carrier generation and recombination, originated from effective electronic coupling and band-like carrier transitions facilitated by the amorphous MoS<sub>x</sub> matrix. Capacitance and resistance analyses further corroborated these findings, revealing minimal photoinduced recombination in a-MoS<sub>x</sub>/CNCs. These results highlight the transformative potential of a-MoS<sub>x</sub>/CNCs in the development of high-performance, durable, and scalable optoelectronic applications.

## Data availability

The data supporting this article have been included as part of the ESI.†

## Author contributions

The manuscript was written through contributions of all authors. H. Kim: conceptualization, formal analysis, writing – original draft, and editing, Y. Jeong: material synthesis and film

fabrication, W.-G. Jung, W.-J. Moon: TEM analysis, M. Kim, J. Yang: material characteristic, M. Kim, Y. Han, H. Ko: formal analysis and visualization, S. W. Hwang: methodology, formal analysis, M. J. Kim, J. W. Lee: formal analysis, H. Lee: conceptualization, editing, resources, and supervision. All authors have given their approval to the final version of the manuscript.

## Conflicts of interest

There are no conflicts to declare.

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